

International
IR Rectifier

IRF7321D2

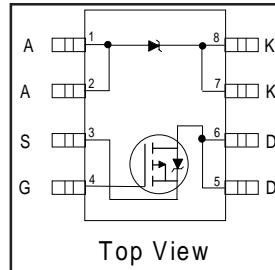
FETKY™ MOSFET & Schottky Diode

- Co-packaged HEXFET® Power MOSFET and Schottky Diode
- Ideal For Buck Regulator Applications
- P-Channel HEXFET®
- Low V_F Schottky Rectifier
- Generation 5 Technology
- SO-8 Footprint

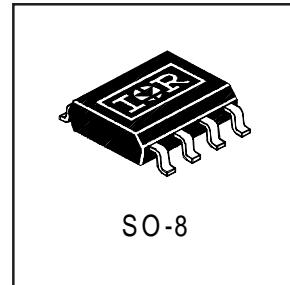
Description

The **FETKY™** family of Co-packaged HEXFETs and Schottky diodes offer the designer an innovative board space saving solution for switching regulator and power management applications. Generation 5 HEXFETs utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. Combining this technology with International Rectifier's low forward drop Schottky rectifiers results in an extremely efficient device suitable for use in a wide variety of portable electronics applications.

The SO-8 has been modified through a customized leadframe for enhanced thermal characteristics. The SO-8 package is designed for vapor phase, infrared or wave soldering techniques.



$V_{DSS} = -30V$
 $R_{DS(on)} = 0.062\Omega$
 Schottky $V_f = 0.52V$



Absolute Maximum Ratings ($T_A = 25^\circ C$ Unless Otherwise Noted)

Parameter	Maximum	Units
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ -10V$	A
$I_D @ T_A = 70^\circ C$		
I_{DM}	-38	
$P_D @ T_A = 25^\circ C$	Power Dissipation	W
$P_D @ T_A = 70^\circ C$		
V_{GS}	16	mW/°C
V_{GS}	± 20	V
dv/dt	Peak Diode Recovery dv/dt ②	V/ns
T_J, T_{STG}	Junction and Storage Temperature Range	°C

Thermal Resistance Ratings

Parameter	Maximum	Units
$R_{θJA}$	62.5	°C/W

Notes:

- ① Repetitive rating – pulse width limited by max. junction temperature (see fig. 11)
- ② $I_{SD} \leq -2.9A$, $di/dt \leq -77A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150^\circ C$
- ③ Pulse width $\leq 300\mu s$ – duty cycle $\leq 2\%$
- ④ Surface mounted on FR-4 board, $t \leq 10sec$.

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MOSFET Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	-30	—	—	V	$V_{\text{GS}} = 0\text{V}$, $I_D = -250\mu\text{A}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	—	0.042	0.062	Ω	$V_{\text{GS}} = -10\text{V}$, $I_D = -4.9\text{A}$ ③
		—	0.076	0.098		$V_{\text{GS}} = -4.5\text{V}$, $I_D = -3.6\text{A}$ ③
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	-1.0	—	—	V	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = -250\mu\text{A}$
g_{fs}	Forward Transconductance	—	7.7	—	S	$V_{\text{DS}} = -15\text{V}$, $I_D = -4.9\text{A}$
I_{DSS}	Drain-to-Source Leakage Current	—	—	-1.0	μA	$V_{\text{DS}} = -24\text{V}$, $V_{\text{GS}} = 0\text{V}$
		—	—	-25		$V_{\text{DS}} = -24\text{V}$, $V_{\text{GS}} = 0\text{V}$, $T_J = 55^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{\text{GS}} = -20\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{\text{GS}} = 20\text{V}$
Q_g	Total Gate Charge	—	23	34	nC	$I_D = -4.9\text{A}$
Q_{gs}	Gate-to-Source Charge	—	3.8	5.7		$V_{\text{DS}} = -15\text{V}$
Q_{gd}	Gate-to-Drain ("Miller") Charge	—	5.9	8.9		$V_{\text{GS}} = -10\text{V}$, See Fig. 6 ③
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	13	19	ns	$V_{\text{DD}} = -15\text{V}$
t_r	Rise Time	—	13	20		$I_D = -1.0\text{A}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	34	51		$R_G = 6.0\Omega$
t_f	Fall Time	—	32	48		$R_D = 15\Omega$, ③
C_{iss}	Input Capacitance	—	710	—	pF	$V_{\text{GS}} = 0\text{V}$
C_{oss}	Output Capacitance	—	380	—		$V_{\text{DS}} = -25\text{V}$
C_{rss}	Reverse Transfer Capacitance	—	180	—		$f = 1.0\text{MHz}$, See Fig. 5

MOSFET Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current(Body Diode)	—	—	-2.5	A	
I_{SM}	Pulsed Source Current (Body Diode)	—	—	-30		
V_{SD}	Body Diode Forward Voltage	—	-0.78	-1.0	V	$T_J = 25^\circ\text{C}$, $I_S = -1.7\text{A}$, $V_{\text{GS}} = 0\text{V}$
t_{rr}	Reverse Recovery Time (Body Diode)	—	44	66	ns	$T_J = 25^\circ\text{C}$, $I_F = -1.7\text{A}$
Q_{rr}	Reverse Recovery Charge	—	42	63	nC	$dI/dt = 100\text{A}/\mu\text{s}$ ③

Schottky Diode Maximum Ratings

	Parameter	Max.	Units	Conditions	
I_f (av)	Max. Average Forward Current	3.2	A	50% Duty Cycle. Rectangular Wave, $T_c = 25^\circ\text{C}$ See Fig.14	$T_c = 70^\circ\text{C}$
		2.0			
I_{SM}	Max. peak one cycle Non-repetitive Surge current	200	A	5μs sine or 3μs Rect. pulse	Following any rated load condition & with V_{rrm} applied
		20		10ms sine or 6ms Rect. pulse	

Schottky Diode Electrical Specifications

	Parameter	Max.	Units	Conditions	
V_{fm}	Max. Forward voltage drop	0.57	V	$I_f = 3.0$, $T_J = 25^\circ\text{C}$	
		0.77		$I_f = 6.0$, $T_J = 25^\circ\text{C}$	
		0.52		$I_f = 3.0$, $T_J = 125^\circ\text{C}$	
		0.79		$I_f = 6.0$, $T_J = 125^\circ\text{C}$	
I_{rm}	Max. Reverse Leakage current	0.30	mA	$V_r = 30\text{V}$	$T_J = 25^\circ\text{C}$
		37			$T_J = 125^\circ\text{C}$
C_t	Max. Junction Capacitance	310	pF	$V_r = 5\text{Vdc}$ (100kHz to 1 MHz) 25°C	
dv/dt	Max. Voltage Rate of Change	4900	V/μs	Rated V_r	

(HEXFET is the reg. TM for International Rectifier Power MOSFET's)

Power Mosfet Characteristics

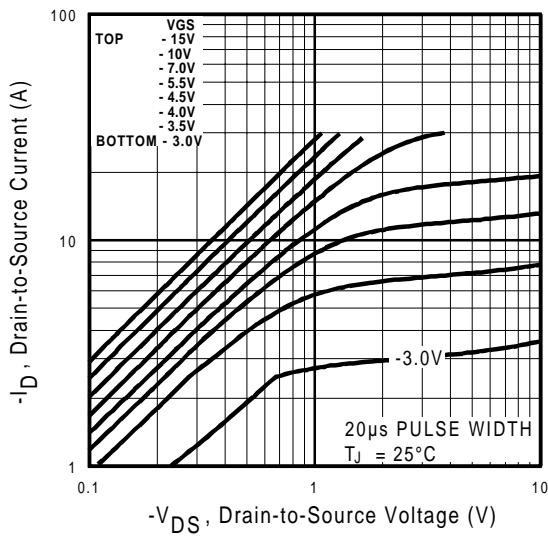


Fig 1. Typical Output Characteristics

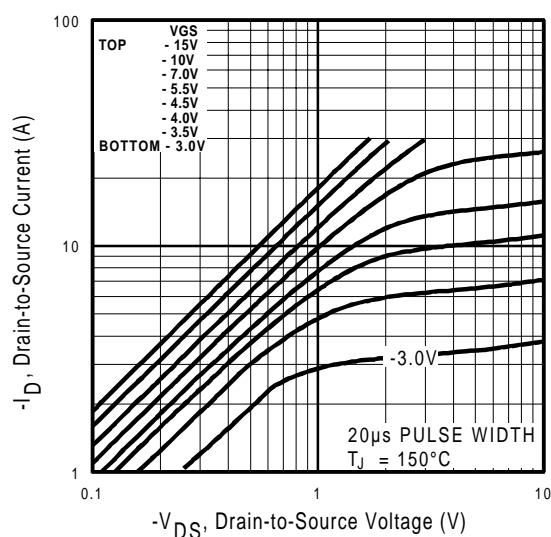


Fig 2. Typical Output Characteristics

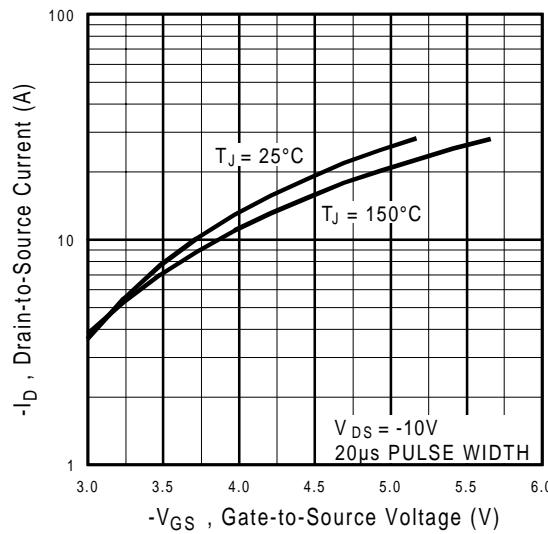


Fig 3. Typical Transfer Characteristics

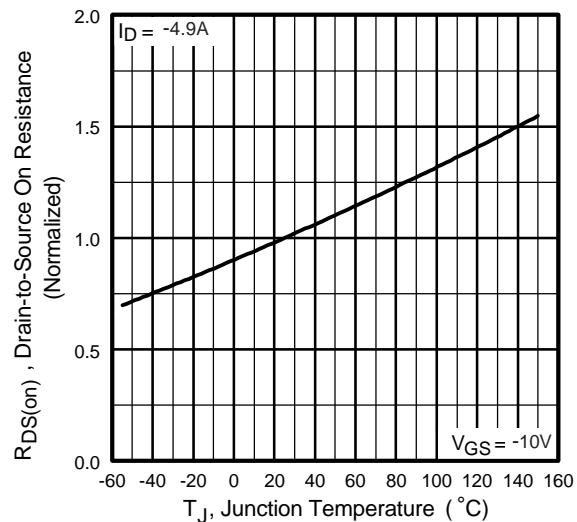


Fig 4. Normalized On-Resistance
Vs. Temperature

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Power Mosfet Characteristics

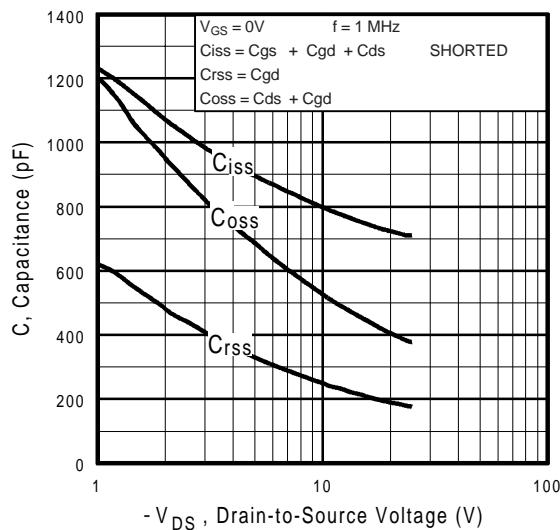


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

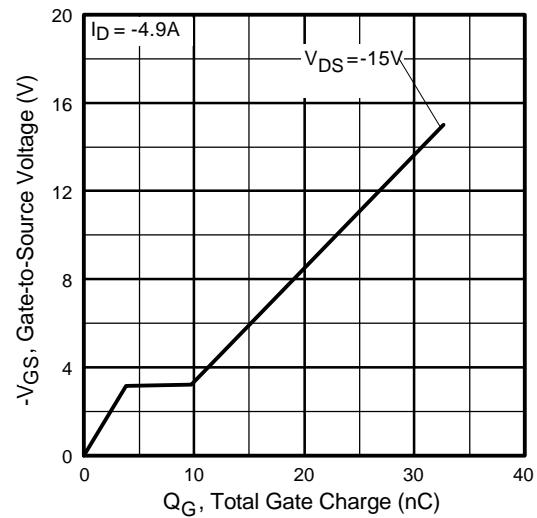


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

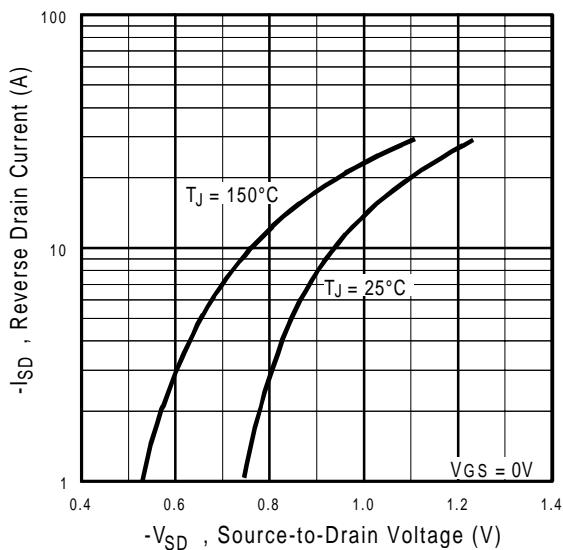


Fig 7. Typical Source-Drain Diode
Forward Voltage

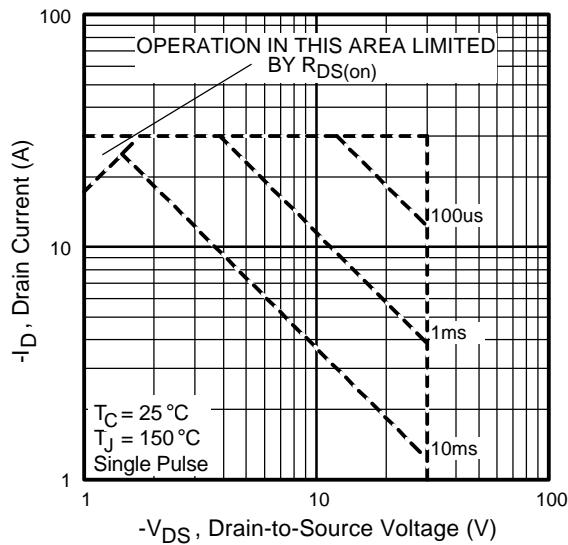


Fig 8. Maximum Safe Operating Area

Power Mosfet Characteristics

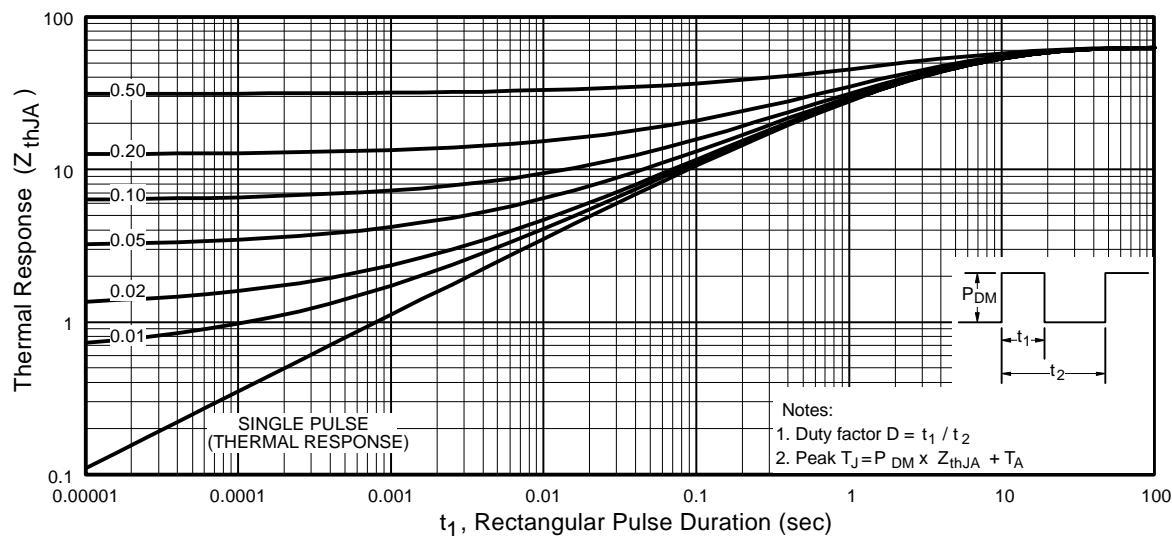


Fig 9. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

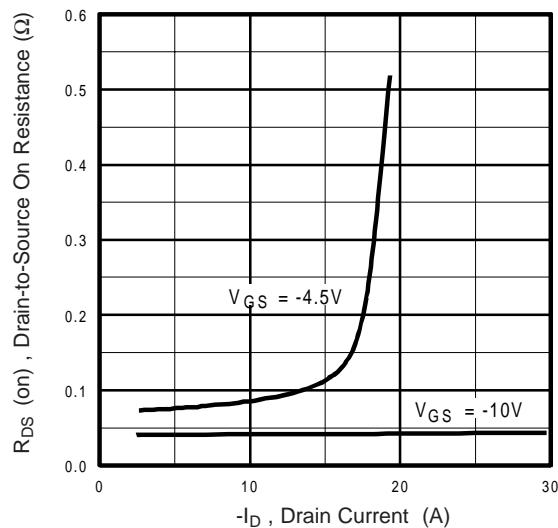


Fig 10. Typical On-Resistance Vs. Drain Current

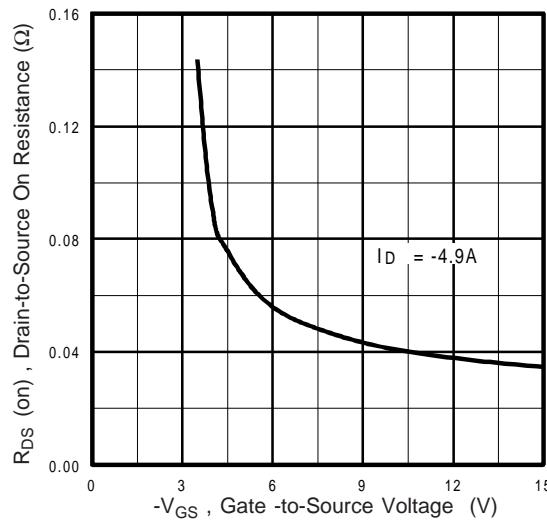


Fig 11. Typical On-Resistance Vs. Gate Voltage

Schottky Diode Characteristics

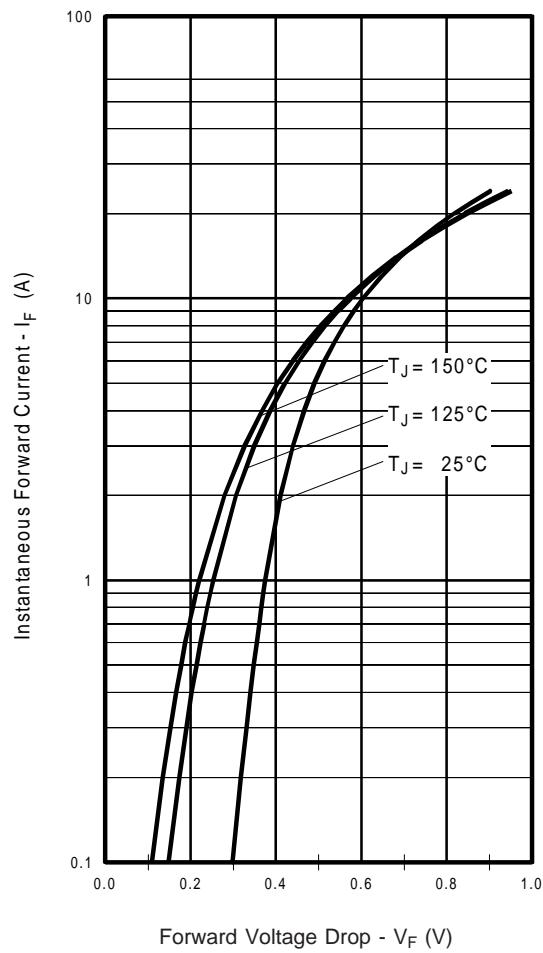


Fig. 12 - Typical Forward Voltage Drop Characteristics

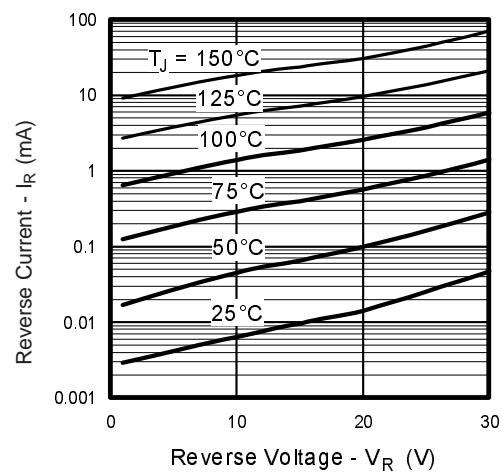


Fig. 13 - Typical Values of Reverse Current Vs. Reverse Voltage

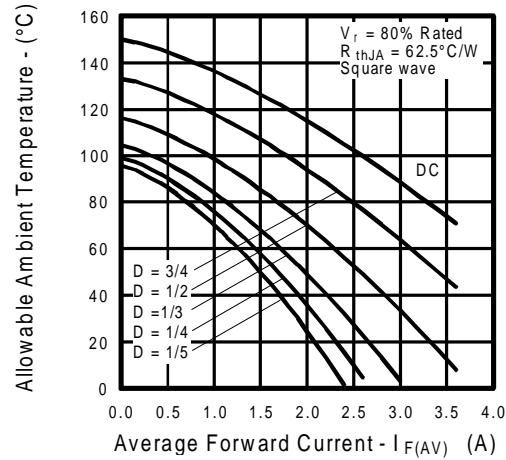
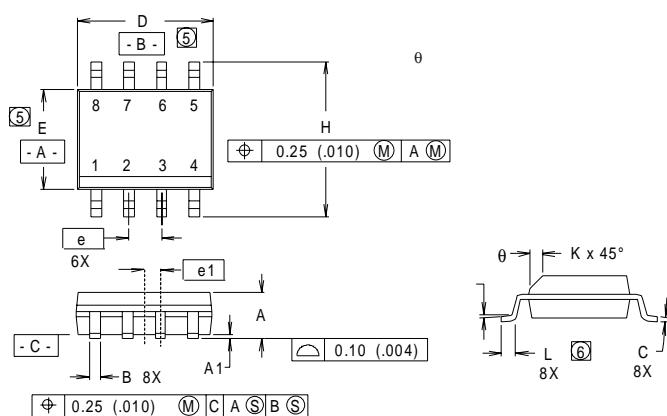


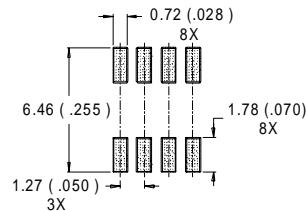
Fig.14 - Maximum Allowable Ambient Temp. Vs. Forward Current

SO-8 Package Details



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
B	.014	.018	0.36	0.46
C	.0075	.0098	0.19	0.25
D	.189	.196	4.80	4.98
E	.150	.157	3.81	3.99
e	.050 BASIC		1.27 BASIC	
e1	.025 BASIC		0.635 BASIC	
H	.2284	.2440	5.80	6.20
K	.011	.019	0.28	0.48
L	.016	.050	0.41	1.27
θ	0°	8°	0°	8°

RECOMMENDED FOOTPRINT

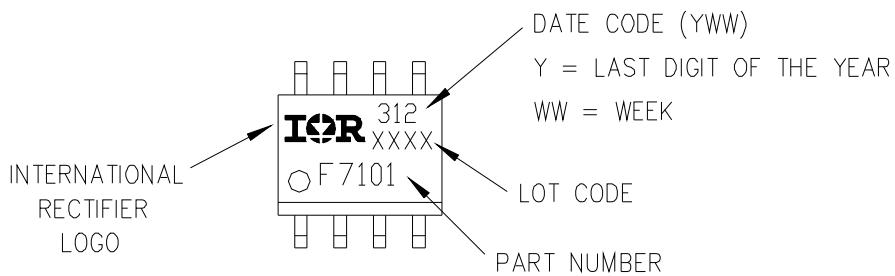


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION : INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
5. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS
MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.006).
6. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE..

Part Marking

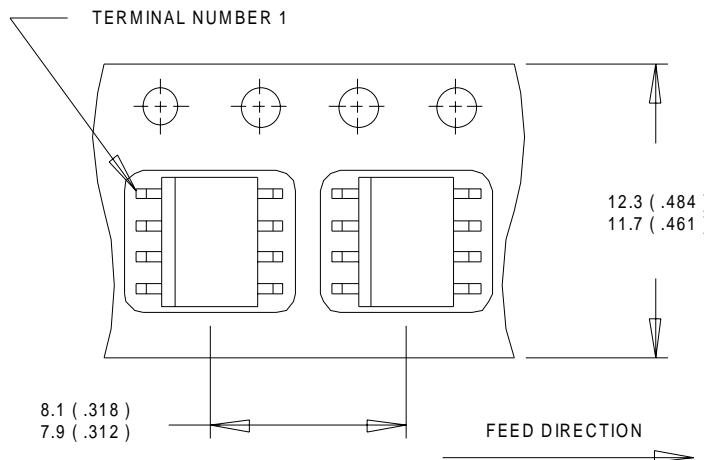
EXAMPLE: THIS IS AN IRF7101



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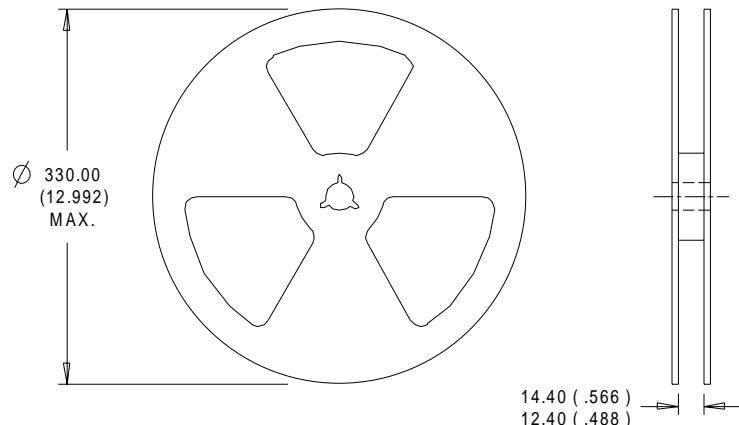
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Tape and Reel



NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

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WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, Tel: (310) 322 3331

IR GREAT BRITAIN: Hurst Green, Oxted, Surrey RH8 9BB, UK Tel: ++ 44 1883 73200

IR CANADA: 15 Lincoln Court, Brampton, Ontario L6T3Z2, Tel: (905) 453 2200

IR GERMANY: Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 6172 96590

IR ITALY: Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111

IR FAR EAST: K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo Japan 171 Tel: 81 3 3983 0086

IR SOUTHEAST ASIA: 1 Kim Seng Promenade, Great World City West Tower, 13-11, Singapore 237994 Tel: ++ 65 221 8371

IR TAIWAN: 16 Fl. Suite D. 207, Sec. 2, Tun Haw South Road, Taipei, 10673, Taiwan Tel: 886-2-2377-9936

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